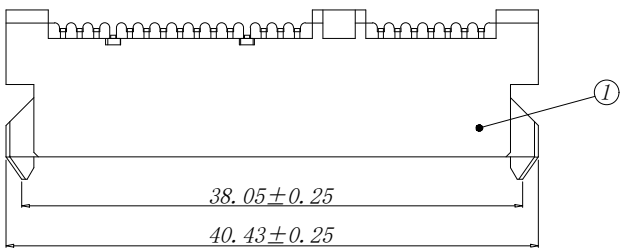
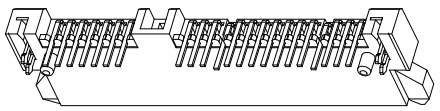
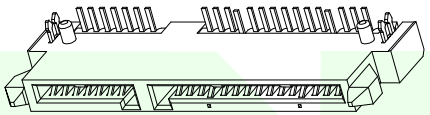
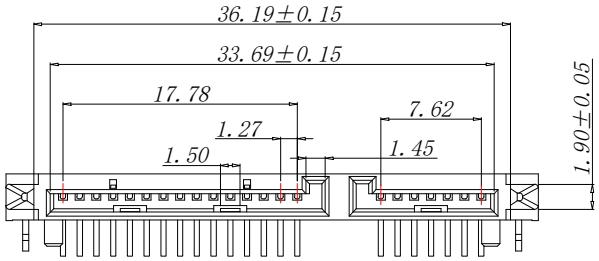
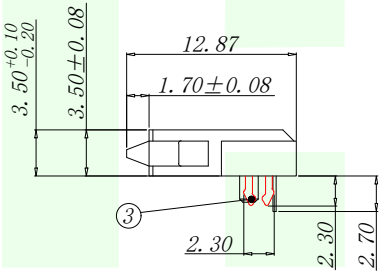
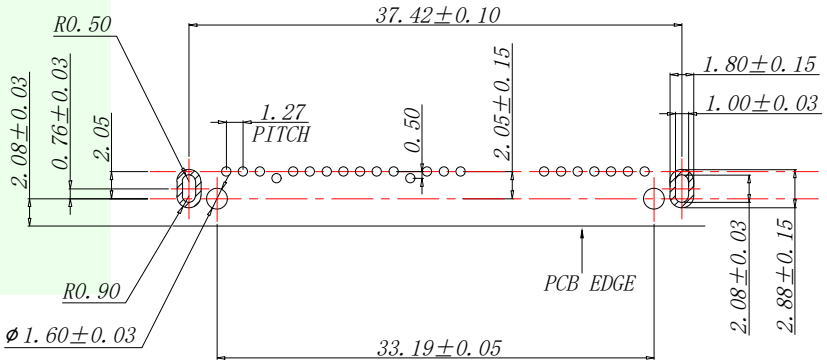


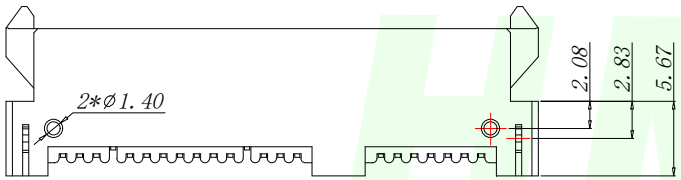





RECOMMEND PCB LAYOUT (T=1.2)



SPECIFICATION:

1. MATERIAL:
   HOUSING: LCP UL 94V-0
   COLOR: BLACK
   CONTACT: PHOSPHOR BRONZE C5191R-H, T=0.25mm
   PEG: BRASS C2680R-H, T=0.30mm
2. FINISH:
   CONTACT: 1u" GOLD PLATING ON CONTACT AREA
   100u" TIN PLATING ON SOLDERTAILS
   30u" NICKEL UNDERPLATING OVER ALL
   PEG: 100u" TIN PLATING ON SOLDERTAILS
   30u" NICKEL UNDERPLATING OVER ALL

| 环保要求 | | 产品必须符合ROHS要求 | | |
|---|---|---|---|---|
| 3 | Peg | Brass C2680R-H | | Tin/Ni Plated |
| 2 | Terminal | Pho. Bronze C5191R-H | | Gold/Tin Plated |
| 1 | Housing | High Temp | Black | UL 94V-0 |
| NO. | DESCRIPTION | MATERIAL | COLOR | REMARK |

| | | | |
|---|---|---|---|
| GENERAL TOLERANCES UNLESS SPECIFIED | | 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd | |
| .X±0.30 | .X°±3° | PART NO. HMT-SATA22M-X08C2 | TITLE: SATA 7+15P 母座DIP H:3.50 板上型 |
| .XX±0.20 | .XX°±2° | | |
| .XXX±0.05 | .XXX°±0.5° | DESIGN: James | CUSTOMER / SIZE A4 / UNITS MM |
| MANUFACTURE DWG | | CHED: Talen | SCALE N:A / SHEET 1/1 |
| | | APPD: Sophia | |